

L Number	Hits	Search Text	DB	Time stamp
-	199	thermopile and infrared and semiconductor	USPAT	2003/12/23 12:18
-	1	(thermopile adj detector) and infrared and semiconductor and (chemical adj reagent)	USPAT	2003/04/17 16:10
-	40	(thermopile adj detector) and infrared and semiconductor	USPAT	2003/04/17 16:10
-	28	(thermopile adj detector) and (infrared adj radiation) and semiconductor	USPAT	2003/04/17 16:12
-	6	(thermopile adj detector) and (infrared adj radiation) and semiconductor and (gas with concentration)	USPAT	2003/04/17 16:22
-	0	(thermopile adj detector) and (infrared adj radiation) and semiconductor and scrubber	USPAT	2003/04/17 16:27
-	806	(438/14).CCLS.	USPAT	2003/04/17 16:27
-	1	((438/14).CCLS.) and thermopile	USPAT	2003/04/17 16:27
-	11	(thermopile with detector) and (process with control) and semiconductor	USPAT	2003/04/17 16:28
-	1	("6617175").PN.	USPAT	2003/12/23 12:18
-	49	(thermopile with detector) and (process with control)	USPAT	2003/12/23 12:35
-	6	((("6469303") or ("4935345") or ("5589689") or ("5047352") or ("5650624") or ("5721430")).PN.	USPAT	2003/12/23 12:35

L Number	Hits	Search Text	DB	Time stamp
1	1	("6617175").PN.	USPAT	2004/07/13 12:30
2	1070	(438/14).CCLS.	USPAT	2004/07/13 12:30
3	0	((438/14).CCLS.) and (fluid adj sampling)	USPAT	2004/07/13 12:30
4	2	((438/14).CCLS.) and (fluid) and (infrared adj radiation)	USPAT	2004/07/13 12:31
5	47	(infrared adj radiation) and fluid and thermopile	USPAT	2004/07/13 12:31
6	4	(infrared adj radiation) and fluid and thermopile and (process with control)	USPAT	2004/07/13 12:32
7	22	deposition and (chemical adj reagent) and infrared and semiconductor	USPAT	2004/07/13 12:33
8	1	deposition and (chemical adj reagent) and infrared and semiconductor and thermopile	USPAT	2004/07/13 12:34
9	45	(control with process) and semiconductor and thermopile	USPAT	2004/07/13 12:34
10	9	(control with process) and semiconductor and thermopile and fluid and gas and chamber	USPAT	2004/07/13 12:39
11	14	(thermopile adj detector) and fluid and process and semiconductor and control	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/13 12:39